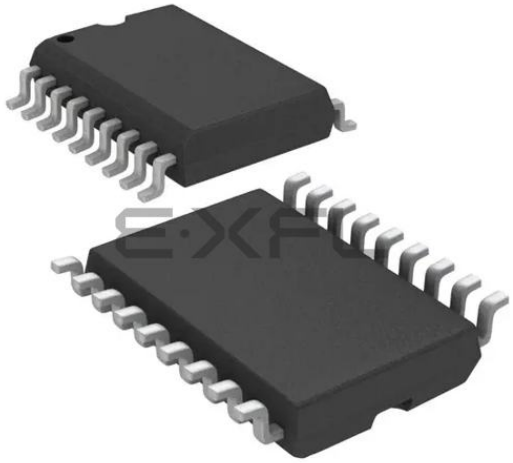

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	16
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	224 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	18-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f628-20i-so

TABLE 2-1: PIC16F62X PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
RA0/AN0	RA0	ST	CMOS	Bi-directional I/O port
	AN0	AN	—	Analog comparator input
RA1/AN1	RA1	ST	CMOS	Bi-directional I/O port
	AN1	AN	—	Analog comparator input
RA2/AN2/VREF	RA2	ST	CMOS	Bi-directional I/O port
	AN2	AN	—	Analog comparator input
	VREF	—	AN	VREF output
RA3/AN3/CMP1	RA3	ST	CMOS	Bi-directional I/O port
	AN3	AN	—	Analog comparator input
	CMP1	—	CMOS	Comparator 1 output
RA4/T0CKI/CMP2	RA4	ST	OD	Bi-directional I/O port
	T0CKI	ST	—	Timer0 clock input
	CMP2	—	OD	Comparator 2 output
RA5/$\overline{\text{MCLR}}$/VPP	RA5	ST	—	Input port
	$\overline{\text{MCLR}}$	ST	—	Master clear
	VPP	—	—	Programming voltage input. When configured as $\overline{\text{MCLR}}$, this pin is an active low RESET to the device. Voltage on $\overline{\text{MCLR}}$/VPP must not exceed VDD during normal device operation.
RA6/OSC2/CLKOUT	RA6	ST	CMOS	Bi-directional I/O port
	OSC2	XTAL	—	Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.
	CLKOUT	—	CMOS	In ER/INTRC mode, OSC2 pin can output CLKOUT, which has 1/4 the frequency of OSC1
RA7/OSC1/CLKIN	RA7	ST	CMOS	Bi-directional I/O port
	OSC1	XTAL	—	Oscillator crystal input
	CLKIN	ST	—	External clock source input. ER biasing pin.
RB0/INT	RB0	TTL	CMOS	Bi-directional I/O port. Can be software programmed for internal weak pull-up.
	INT	ST	—	External interrupt.
RB1/RX/DT	RB1	TTL	CMOS	Bi-directional I/O port. Can be software programmed for internal weak pull-up.
	RX	ST	—	USART receive pin
	DT	ST	CMOS	Synchronous data I/O.
RB2/TX/CK	RB2	TTL	CMOS	Bi-directional I/O port.
	TX	—	CMOS	USART transmit pin
	CK	ST	CMOS	Synchronous clock I/O. Can be software programmed for internal weak pull-up.
RB3/CCP1	RB3	TTL	CMOS	Bi-directional I/O port. Can be software programmed for internal weak pull-up.
	CCP1	ST	CMOS	Capture/Compare/PWM I/O

Legend: O = Output, — = Not used, TTL = TTL Input, CMOS = CMOS Output, I = Input, OD = Open Drain Output, P = Power, ST = Schmitt Trigger Input, AN = Analog

2.1 Clocking Scheme/Instruction Cycle

The clock input (OSC1/CLKIN/RA7 pin) is internally divided by four to generate four non-overlapping quadrature clocks namely Q1, Q2, Q3 and Q4. Internally, the program counter (PC) is incremented every Q1, the instruction is fetched from the program memory and latched into the instruction register in Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow is shown in Figure 2-2.

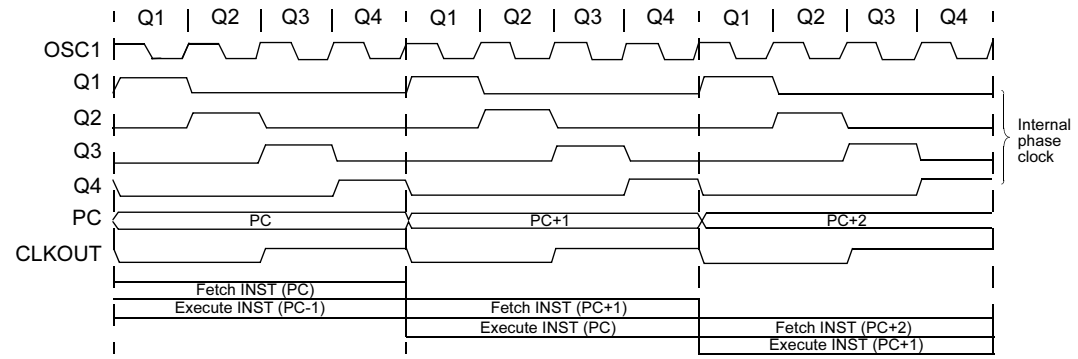
2.2 Instruction Flow/Pipelining

An "Instruction Cycle" consists of four Q cycles (Q1, Q2, Q3 and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change, (e.g., `GOTO`) then two cycles are required to complete the instruction (Example 2-1).

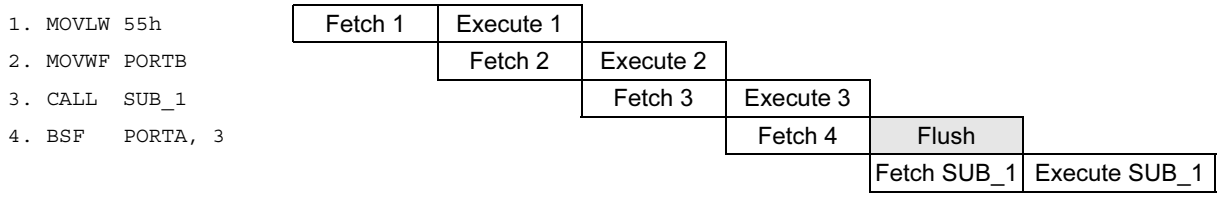
A fetch cycle begins with the program counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the "Instruction Register (IR)" in cycle Q1. This instruction is then decoded and executed during the Q2, Q3, and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

FIGURE 2-2: CLOCK/INSTRUCTION CYCLE



EXAMPLE 2-1: INSTRUCTION PIPELINE FLOW



All instructions are single cycle, except for any program branches. These take two cycles since the fetch instruction is "flushed" from the pipeline while the new instruction is being fetched and then executed.

TABLE 3-2: SPECIAL FUNCTION REGISTERS SUMMARY BANK 1

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset(1)	Details on Page
Bank 1											
80h	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								xxxx xxxx	25
81h	OPTION	$\overline{RBPU}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	20
82h	PCL	Program Counter's (PC) Least Significant Byte								0000 0000	25
83h	STATUS	IRP	RP1	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C	0001 1xxx	19
84h	FSR	Indirect data memory address pointer								xxxx xxxx	25
85h	TRISA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1111 1111	29
86h	TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	1111 1111	34
87h	—	Unimplemented								—	—
88h	—	Unimplemented								—	—
89h	—	Unimplemented								—	—
8Ah	PCLATH	—	—	—	Write buffer for upper 5 bits of program counter					---0 0000	25
8Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	21
8Ch	PIE1	EEIE	CMIE	RCIE	TXIE	—	CCP1IE	TMR2IE	TMR1IE	0000 -000	22
8Dh	—	Unimplemented								—	—
8Eh	PCON	—	—	—	—	OSCF	—	$\overline{POR}$	$\overline{BOD}$	---- 1-0x	24
8Fh	—	Unimplemented								—	—
90h	—	Unimplemented								—	—
91h	—	Unimplemented								—	—
92h	PR2	Timer2 Period Register								1111 1111	50
93h	—	Unimplemented								—	—
94h	—	Unimplemented								—	—
95h	—	Unimplemented								—	—
96h	—	Unimplemented								—	—
97h	—	Unimplemented								—	—
98h	TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	69
99h	SPBRG	Baud Rate Generator Register								0000 0000	69
9Ah	EEDATA	EEPROM data register								xxxx xxxx	87
9Bh	EEADR	—	EEPROM address register							xxxx xxxx	87
9Ch	EECON1	—	—	—	—	WRERR	WREN	WR	RD	---- x000	87
9Dh	EECON2	EEPROM control register 2 (not a physical register)								--------	87
9Eh	—	Unimplemented								—	—
9Fh	VRCON	VREN	VROE	VRR	—	VR3	VR2	VR1	VR0	000- 0000	59

Legend: — = Unimplemented locations read as '0', u = unchanged, x = unknown, q = value depends on condition, shaded = unimplemented

Note 1: For the Initialization Condition for Registers Tables, refer to Table 14-7 and Table 14-8 on page 98.

3.2.2.5 PIR1 Register

This register contains interrupt flag bits.

Note:	Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 3-5: PIR1 REGISTER (ADDRESS: 0Ch)

R/W-0	R/W-0	R-0	R-0	U-0	R/W-0	R/W-0	R/W-0
EEIF	CMIF	RCIF	TXIF	—	CCP1IF	TMR2IF	TMR1IF
bit 7							bit 0

bit 7 **EEIF:** EEPROM Write Operation Interrupt Flag bit
1 = The write operation completed (must be cleared in software)
0 = The write operation has not completed or has not been started

bit 6 **CMIF**: Comparator Interrupt Flag bit
1 = Comparator output has changed
0 = Comparator output has not changed

bit 5 **RCIF**: USART Receive Interrupt Flag bit
1 = The USART receive buffer is full
0 = The USART receive buffer is empty

bit 4 **TXIF**: USART Transmit Interrupt Flag bit
1 = The USART transmit buffer is empty
0 = The USART transmit buffer is full

bit 3 **Unimplemented**: Read as '0'

bit 2 **CCP1IF**: CCP1 Interrupt Flag bit
Capture Mode
1 = A TMR1 register capture occurred (must be cleared in software)
0 = No TMR1 register capture occurred
Compare Mode
1 = A TMR1 register compare match occurred (must be cleared in software)
0 = No TMR1 register compare match occurred
PWM Mode
Unused in this mode

bit 1 **TMR2IF**: TMR2 to PR2 Match Interrupt Flag bit
1 = TMR2 to PR2 match occurred (must be cleared in software)
0 = No TMR2 to PR2 match occurred

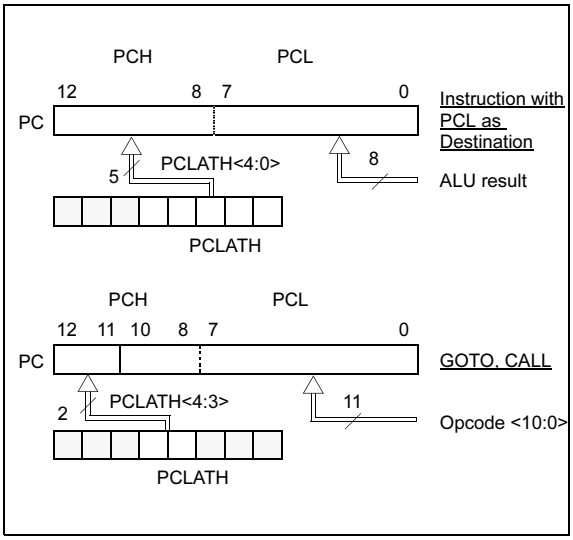
bit 0 **TMR1IF**: TMR1 Overflow Interrupt Flag bit
1 = TMR1 register overflowed (must be cleared in software)
0 = TMR1 register did not overflow

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

3.3 PCL and PCLATH

The program counter (PC) is 13-bits wide. The low byte comes from the PCL register, which is a readable and writable register. The high byte (PC<12:8>) is not directly readable or writable and comes from PCLATH. On any RESET, the PC is cleared. Figure 3-3 shows the two situations for the loading of the PC. The upper example in the figure shows how the PC is loaded on a write to PCL (PCLATH<4:0> → PCH). The lower example in the figure shows how the PC is loaded during a CALL or GOTO instruction (PCLATH<4:3> → PCH).

FIGURE 3-3: LOADING OF PC IN DIFFERENT SITUATIONS



3.3.1 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When doing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256 byte block). Refer to the application note *"Implementing a Table Read"* (AN556).

3.3.2 STACK

The PIC16F62X family has an 8-level deep x 13-bit wide hardware stack (Figure 3-1 and Figure 3-2). The stack space is not part of either program or data space and the stack pointer is not readable or writable. The PC is PUSHed onto the stack when a CALL instruction is executed or an interrupt causes a branch. The stack is POPed in the event of a RETURN, RETLW or a RETFIE instruction execution. PCLATH is not affected by a PUSH or POP operation.

The stack operates as a circular buffer. This means that after the stack has been PUSHed eight times, the ninth push overwrites the value that was stored from the first push. The tenth push overwrites the second push (and so on).

Note 1: There are no STATUS bits to indicate stack overflow or stack underflow conditions.

2: There are no instructions/mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, RETURN, RETLW and RETFIE instructions, or the vectoring to an interrupt address.

3.4 Indirect Addressing, INDF and FSR Registers

The INDF register is not a physical register. Addressing the INDF register will cause indirect addressing.

Indirect addressing is possible by using the INDF register. Any instruction using the INDF register actually accesses data pointed to by the file select register (FSR). Reading INDF itself indirectly will produce 00h. Writing to the INDF register indirectly results in a no-operation (although STATUS bits may be affected). An effective 9-bit address is obtained by concatenating the 8-bit FSR register and the IRP bit (STATUS<7>), as shown in Figure 3-4.

A simple program to clear RAM location 20h-2Fh using indirect addressing is shown in Example 3-1.

EXAMPLE 3-1: Indirect Addressing

```
        movlw   0x20    ;initialize pointer
        movwf   FSR     ;to RAM
NEXT    clrf    INDF    ;clear INDF register
        incf    FSR     ;inc pointer
        btfss   FSR,4   ;all done?
        goto    NEXT    ;no clear next
                        ;yes continue
```

5.0 I/O PORTS

The PIC16F62X have two ports, PORTA and PORTB. Some pins for these I/O ports are multiplexed with an alternate function for the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

5.1 PORTA and TRISA Registers

PORTA is an 8-bit wide latch. RA4 is a Schmitt Trigger input and an open drain output. Port RA4 is multiplexed with the T0CKI clock input. RA5 is a Schmitt Trigger input only and has no output drivers. All other RA port pins have Schmitt Trigger input levels and full CMOS output drivers. All pins have data direction bits (TRIS registers) which can configure these pins as input or output.

A '1' in the TRISA register puts the corresponding output driver in a Hi-impedance mode. A '0' in the TRISA register puts the contents of the output latch on the selected pin(s).

Reading the PORTA register reads the status of the pins whereas writing to it will write to the port latch. All write operations are read-modify-write operations. So a write to a port implies that the port pins are first read, then this value is modified and written to the port data latch.

The PORTA pins are multiplexed with comparator and voltage reference functions. The operation of these pins are selected by control bits in the CMCON (comparator control register) register and the VRCON (voltage reference control register) register. When selected as a comparator input, these pins will read as '0's.

Note:	RA5 shares function with VPP. When VPP voltage levels are applied to RA5, the device will enter Programming mode.

Note 1:	On RESET, the TRISA register is set to all inputs. The digital inputs are disabled and the comparator inputs are forced to ground to reduce current consumption.
2:	TRISA<6:7> is overridden by oscillator configuration. When PORTA<6:7> is overridden, the data reads '0' and the TRISA<6:7> bits are ignored.

TRISA controls the direction of the RA pins, even when they are being used as comparator inputs. The user must make sure to keep the pins configured as inputs when using them as comparator inputs.

The RA2 pin will also function as the output for the voltage reference. When in this mode, the VREF pin is a very high impedance output. The user must configure TRISA<2> bit as an input and use high impedance loads.

In one of the Comparator modes defined by the CMCON register, pins RA3 and RA4 become outputs of the comparators. The TRISA<4:3> bits must be cleared to enable outputs to use this function.

EXAMPLE 5-1: Initializing PORTA

```
CLRF  PORTA       ;Initialize PORTA by
                  ;setting output data latches
MOVLW 0x07        ;Turn comparators off and
MOVWF CMCON       ;enable pins for I/O
                  ;functions
BCF   STATUS, RP1
BSF   STATUS, RP0;Select Bank1
MOVLW 0x1F        ;Value used to initialize
                  ;data direction
MOVWF TRISA       ;Set RA<4:0> as inputs
                  ;TRISA<5> always
                  ;read as '1'.
                  ;TRISA<7:6>
                  ;depend on oscillator mode
```

FIGURE 5-4: BLOCK DIAGRAM OF RA4/T0CKI PIN

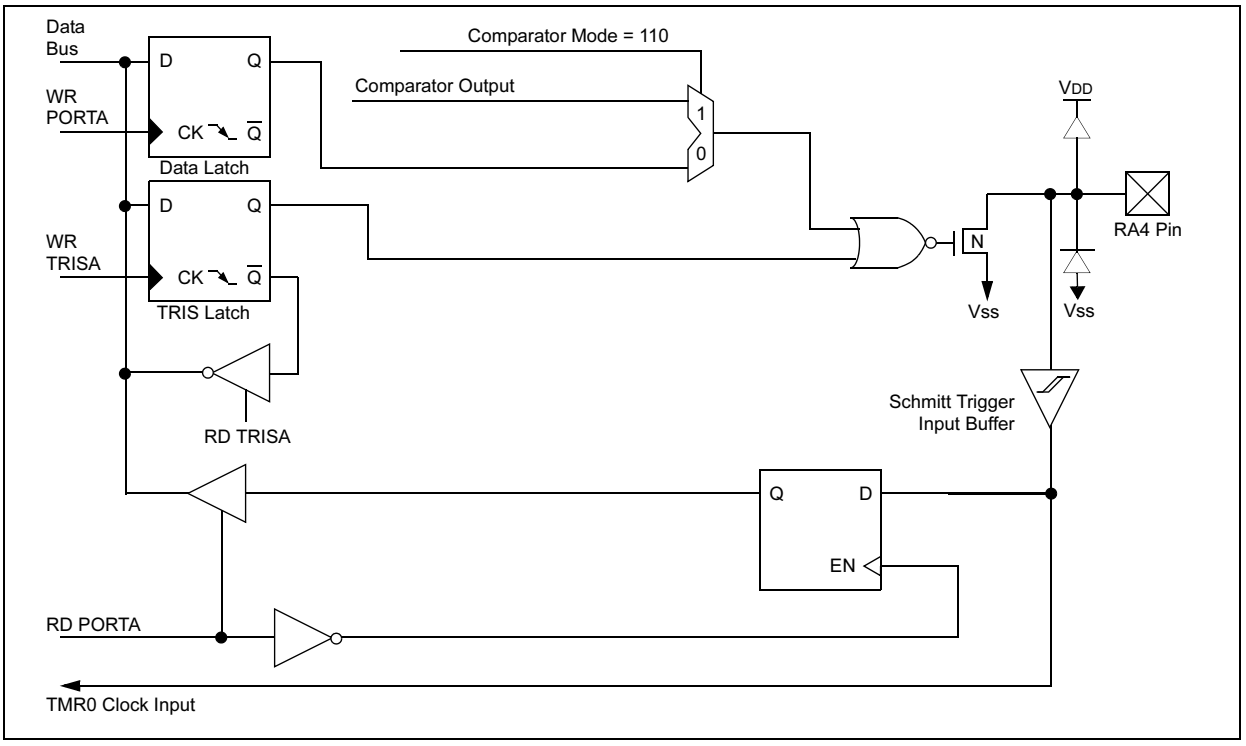


FIGURE 5-5: BLOCK DIAGRAM OF THE RA5/$\overline{MCLR}$/VPP PIN

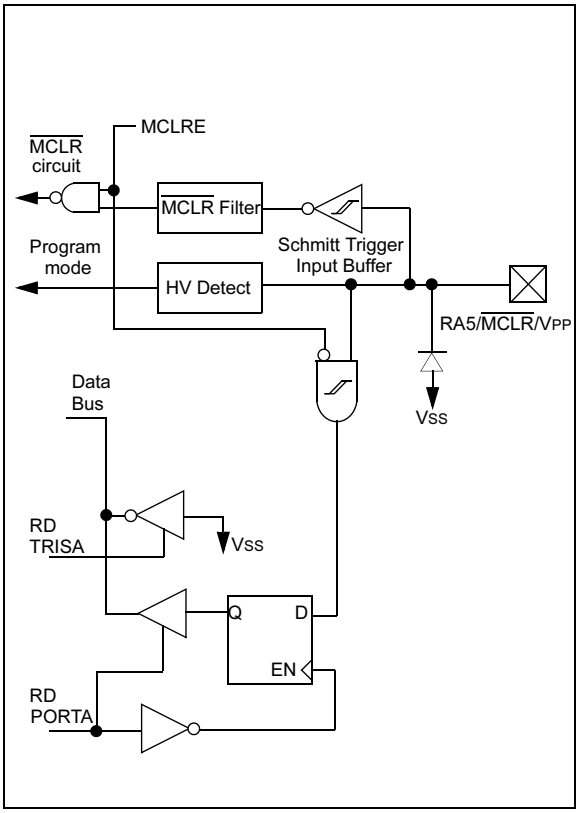
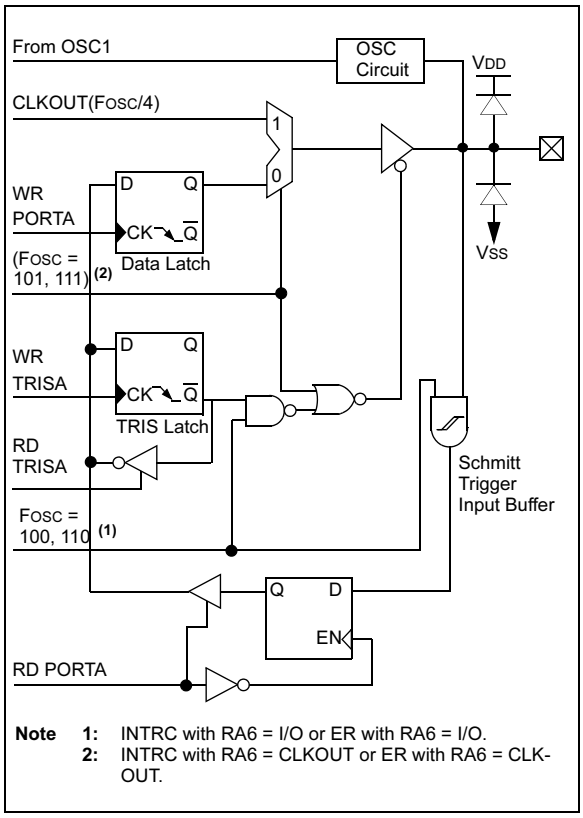
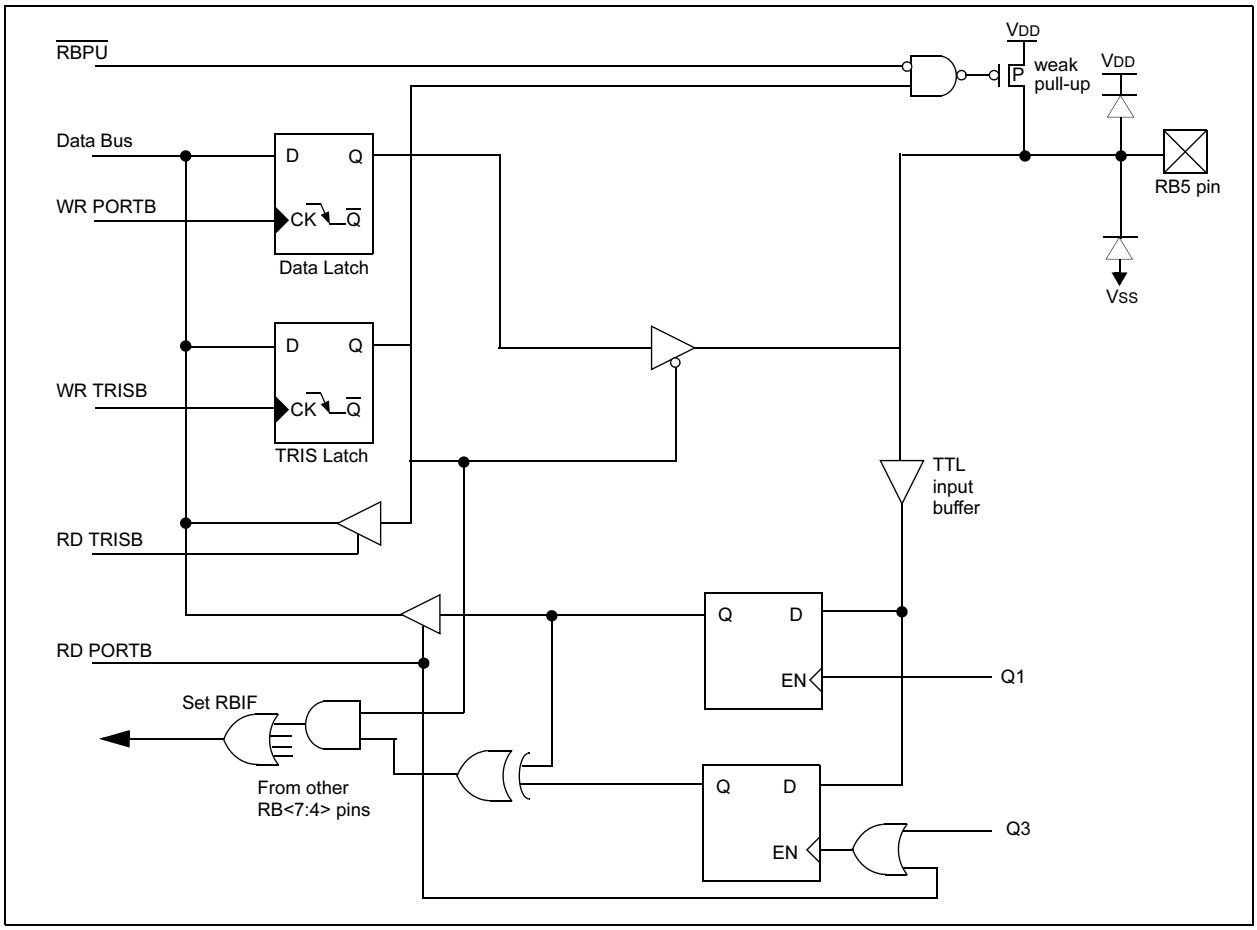


FIGURE 5-6: BLOCK DIAGRAM OF RA6/OSC2/CLKOUT PIN



Note 1: INTRC with RA6 = I/O or ER with RA6 = I/O.
2: INTRC with RA6 = CLKOUT or ER with RA6 = CLKOUT.

FIGURE 5-13: BLOCK DIAGRAM OF RB5 PIN



14.5 Power-on Reset (POR), Power-up Timer (PWRT), Oscillator Start-up Timer (OST) and Brown-out Detect (BOD)

14.5.1 POWER-ON RESET (POR)

The on-chip POR circuit holds the chip in RESET until VDD has reached a high enough level for proper operation. To take advantage of the POR, just tie the MCLR pin through a resistor to VDD. This will eliminate external RC components usually needed to create Power-on Reset. A maximum rise time for VDD is required. See Electrical Specifications for details.

The POR circuit does not produce an internal RESET when VDD declines.

When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met.

For additional information, refer to Application Note AN607, “Power-up Trouble Shooting”.

14.5.2 POWER-UP TIMER (PWRT)

The PWRT provides a fixed 72 ms (nominal) timeout on power-up only, from POR or Brown-out Detect Reset. The PWRT operates on an internal RC oscillator. The chip is kept in RESET as long as PWRT is active. The PWRT delay allows the VDD to rise to an acceptable level. A configuration bit, PWRTE can disable (if set) or enable (if cleared or programmed) the PWRT. The PWRT should always be enabled when Brown-out Detect Reset is enabled.

The Power-Up Time delay will vary from chip to chip and due to VDD, temperature and process variation. See DC parameters for details.

14.5.3 OSCILLATOR START-UP TIMER (OST)

The OST provides a 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures that the crystal oscillator or resonator has started and stabilized.

The OST timeout is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

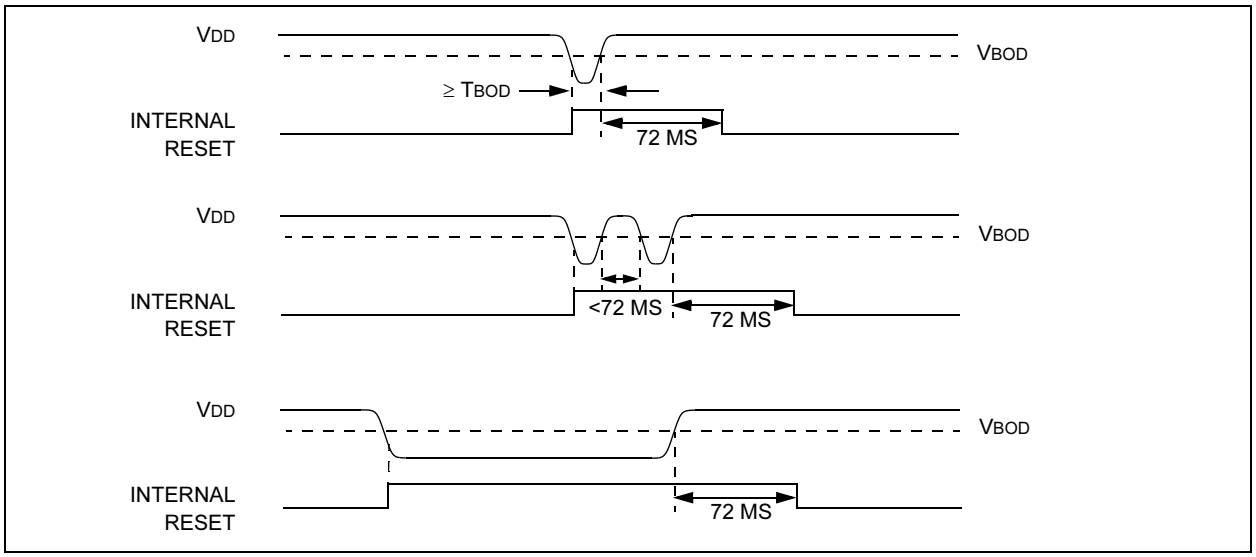
14.5.4 BROWN-OUT DETECT (BOD) RESET

The PIC16F62X members have on-chip BOD circuitry. A configuration bit, BODEN, can disable (if clear/programmed) or enable (if set) the BOD Reset circuitry. If VDD falls below VBOD for longer than TBOD, the brown-out situation will RESET the chip. A RESET is not guaranteed to occur if VDD falls below VBOD for shorter than TBOD. VBOD and TBOD are defined in Table 17-1 and Table 17-6, respectively.

On any RESET (Power-on, Brown-out, Watchdog, etc.) the chip will remain in RESET until VDD rises above VBOD. The Power-up Timer will now be invoked and will keep the chip in RESET an additional 72 ms.

If VDD drops below VBOD while the Power-up Timer is running, the chip will go back into a Brown-out Detect Reset and the Power-up Timer will be re-initialized. Once VDD rises above VBOD, the Power-Up Timer will execute a 72 ms RESET. The Power-up Timer should always be enabled when Brown-out Detect is enabled. Figure 14-7 shows typical Brown-out situations.

FIGURE 14-7: BROWN-OUT SITUATIONS



14.6 Interrupts

The PIC16F62X has 10 sources of interrupt:

- External Interrupt RB0/INT
- TMR0 Overflow Interrupt
- PORTB Change Interrupts (pins RB7:RB4)
- Comparator Interrupt
- USART Interrupt TX
- USART Interrupt RX
- CCP Interrupt
- TMR1 Overflow Interrupt
- TMR2 Match Interrupt
- EEPROM

The interrupt control register (INTCON) records individual interrupt requests in flag bits. It also has individual and global interrupt enable bits.

A global interrupt enable bit, GIE (INTCON<7>) enables (if set) all un-masked interrupts or disables (if cleared) all interrupts. Individual interrupts can be disabled through their corresponding enable bits in INTCON register. GIE is cleared on RESET.

The "return from interrupt" instruction, `RETFIE`, exits interrupt routine as well as sets the GIE bit, which re-enable RB0/INT interrupts.

The INT pin interrupt, the RB port change interrupt and the TMR0 overflow interrupt flags are contained in the INTCON register.

The peripheral interrupt flag is contained in the special register PIR1. The corresponding interrupt enable bit is contained in special registers PIE1.

When an interrupt is responded to, the GIE is cleared to disable any further interrupt, the return address is pushed into the stack and the PC is loaded with 0004h. Once in the interrupt service routine the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid RB0/INT recursive interrupts.

For external interrupt events, such as the INT pin or PORTB change interrupt, the interrupt latency will be three or four instruction cycles. The exact latency depends when the interrupt event occurs (Figure 14-15). The latency is the same for one or two cycle instructions. Once in the interrupt service routine the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid multiple interrupt requests. Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit.

Note 1: Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit.

2: When an instruction that clears the GIE bit is executed, any interrupts that were pending for execution in the next cycle are ignored. The CPU will execute a `NOP` in the cycle immediately following the instruction which clears the GIE bit. The interrupts which were ignored are still pending to be serviced when the GIE bit is set again.

FIGURE 14-14: INTERRUPT LOGIC

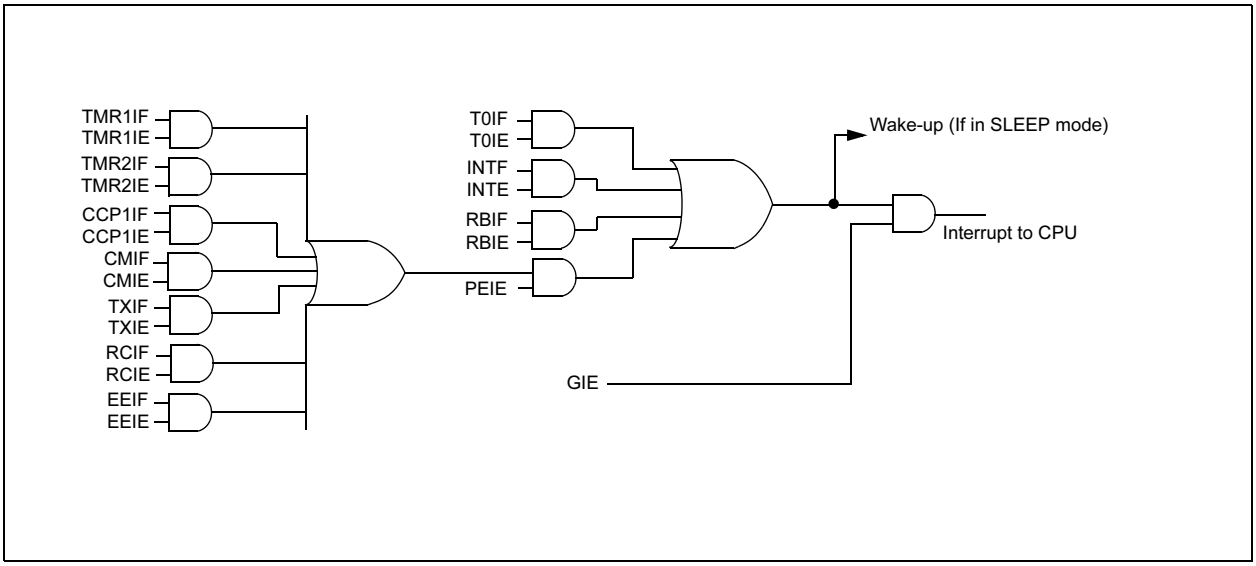
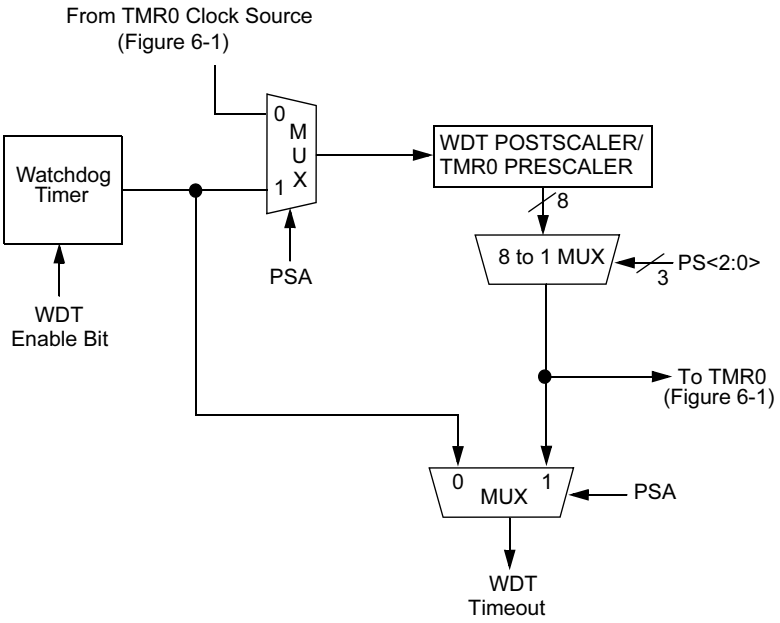


FIGURE 14-16: WATCHDOG TIMER BLOCK DIAGRAM



Note 1: T0SE, T0CS, PSA, PS0-PS2 are bits in the OPTION register.

TABLE 14-10: SUMMARY OF WATCHDOG TIMER REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset	Value on all other RESETS
2007h	Config. bits	LVP	BODEN	MCLRE	FOSC2	$\overline{\text{PWRTE}}$	WDTE	FOSC1	FOSC0	uuuu uuuu	uuuu uuuu
81h	OPTION	$\overline{\text{RBPU}}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111

Legend: – = Unimplemented location, read as "0", + = Reserved for future use
Note 1: Shaded cells are not used by the Watchdog Timer.

14.9 Power-Down Mode (SLEEP)

The Power-down mode is entered by executing a SLEEP instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the $\overline{\text{PD}}$ bit in the STATUS register is cleared, the $\overline{\text{TO}}$ bit is set, and the oscillator driver is turned off. The I/O ports maintain the status they had, before SLEEP was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, all I/O pins should be either at VDD, or VSS, with no external circuitry drawing current from the I/O pin and the comparators, and VREF should be disabled. I/O pins that are hi-impedance inputs should be pulled high or low externally to avoid switching currents caused by floating inputs. The T0CKI input should also be at VDD or VSS for lowest current consumption. The contribution from on-chip pull-ups on PORTB should be considered.

The $\overline{\text{MCLR}}$ pin must be at a logic high level (VIHMC).

Note:	It should be noted that a RESET generated by a WDT timeout does not drive $\overline{\text{MCLR}}$ pin low.

14.9.1 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

1. External RESET input on $\overline{MCLR}$ pin
2. Watchdog Timer Wake-up (if WDT was enabled)
3. Interrupt from RB0/INT pin, RB Port change, or the Peripheral Interrupt (Comparator).

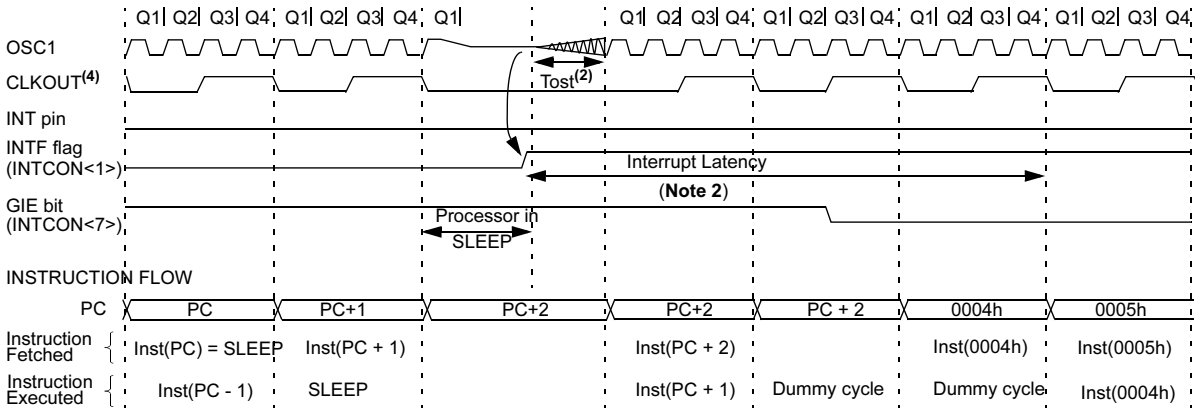
The first event will cause a device RESET. The two latter events are considered a continuation of program execution. The $\overline{TO}$ and $\overline{PD}$ bits in the STATUS register can be used to determine the cause of device RESET. $\overline{PD}$ bit, which is set on power-up is cleared when SLEEP is invoked. $\overline{TO}$ bit is cleared if WDT Wake-up occurred.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and then branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have an NOP after the SLEEP instruction.

Note:	If the global interrupts are disabled (GIE is cleared), but any interrupt source has both its interrupt enable bit and the corresponding interrupt flag bits set, the device will immediately wake-up from SLEEP. The SLEEP instruction is completely executed.

The WDT is cleared when the device wakes-up from SLEEP, regardless of the source of wake-up.

FIGURE 14-17: WAKE-UP FROM SLEEP THROUGH INTERRUPT



Note 1: XT, HS or LP Oscillator mode assumed.
2: TOST = 1024TOSC (drawing not to scale). Approximately 1 μs delay will be there for ER Osc mode.
3: GIE = '1' assumed. In this case after wake- up, the processor jumps to the interrupt routine. If GIE = '0', execution will continue in-line.
4: CLKOUT is not available in these Osc modes, but shown here for timing reference.

14.10 Code Protection

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

Note:	The entire data EEPROM and FLASH program memory will be erased when the code protection is turned off. The INTRC calibration data is not erased.

14.11 User ID Locations

Four memory locations (2000h-2003h) are designated as user ID locations where the user can store checksum or other code-identification numbers. These locations are not accessible during normal execution but are readable and writable during program/verify. Only the Least Significant 4 bits of the user ID locations are used.

INCF **Increment f**

Syntax: [*label*] INCF f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: (f) + 1 → (dest)

Status Affected: Z

Encoding:

00	1010	dfff	ffff

Description: The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.

Words: 1

Cycles: 1

Example

```
INCF    REG1, 1
```

Before Instruction
REG1 = 0xFF
Z = 0
After Instruction
REG1 = 0x00
Z = 1

INCFSZ **Increment f, Skip if 0**

Syntax: [*label*] INCFSZ f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: (f) + 1 → (dest), skip if result = 0

Status Affected: None

Encoding:

00	1111	dfff	ffff

Description: The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.
If the result is 0, the next instruction, which is already fetched, is discarded. A NOP is executed instead making it a two-cycle instruction.

Words: 1

Cycles: 1(2)

Example

```
HERE     INCFSZ    REG1, 1
         GOTO      LOOP
CONTINUE •
         •
         •
```

Before Instruction
PC = address HERE
After Instruction
REG1 = REG1 + 1
if CNT = 0,
PC = address CONTINUE
if REG1≠ 0,
PC = address HERE +1

MOVWF	Move W to f
Syntax:	[*label*] MOVWF f
Operands:	$0 \le f \le 127$
Operation:	(W) → (f)
Status Affected:	None
Encoding:	00 | 0000 | 1fff | ffff
Description:	Move data from W register to register 'f'.
Words:	1
Cycles:	1
Example	`MOVWF REG1` Before Instruction REG1 = 0xFF W = 0x4F After Instruction REG1 = 0x4F W = 0x4F

OPTION	Load Option Register
Syntax:	[*label*] OPTION
Operands:	None
Operation:	(W) → OPTION
Status Affected:	None
Encoding:	00 | 0000 | 0110 | 0010
Description:	The contents of the W register are loaded in the OPTION register. This instruction is supported for code compatibility with PIC16C5X products. Since OPTION is a readable/writable register, the user can directly address it. Using only register instruction such as `MOVWF`.
Words:	1
Cycles:	1
Example	**To maintain upward compatibility with future PICmicro® products, do not use this instruction.**

NOP	No Operation
Syntax:	[*label*] NOP
Operands:	None
Operation:	No operation
Status Affected:	None
Encoding:	00 | 0000 | 0xx0 | 0000
Description:	No operation.
Words:	1
Cycles:	1
Example	`NOP`

RETFIE	Return from Interrupt
Syntax:	[*label*] RETFIE
Operands:	None
Operation:	TOS → PC, 1 → GIE
Status Affected:	None
Encoding:	00 | 0000 | 0000 | 1001
Description:	Return from Interrupt. Stack is POPed and Top of Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a two-cycle instruction.
Words:	1
Cycles:	2
Example	`RETFIE` After Interrupt PC = TOS GIE = 1

16.14 PICDEM 1 PICmicro Demonstration Board

The PICDEM 1 demonstration board demonstrates the capabilities of the PIC16C5X (PIC16C54 to PIC16C58A), PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The sample microcontrollers provided with the PICDEM 1 demonstration board can be programmed with a PRO MATE II device programmer, or a PICSTART Plus development programmer. The PICDEM 1 demonstration board can be connected to the MPLAB ICE in-circuit emulator for testing. A prototype area extends the circuitry for additional application components. Features include an RS-232 interface, a potentiometer for simulated analog input, push button switches and eight LEDs.

16.15 PICDEM.net Internet/Ethernet Demonstration Board

The PICDEM.net demonstration board is an Internet/ Ethernet demonstration board using the PIC18F452 microcontroller and TCP/IP firmware. The board supports any 40-pin DIP device that conforms to the standard pinout used by the PIC16F877 or PIC18C452. This kit features a user friendly TCP/IP stack, web server with HTML, a 24L256 Serial EEPROM for Xmodem download to web pages into Serial EEPROM, ICSP/MPLAB ICD 2 interface connector, an Ethernet interface, RS-232 interface, and a 16 x 2 LCD display. Also included is the book and CD-ROM *"TCP/IP Lean, Web Servers for Embedded Systems,"* by Jeremy Bentham

16.16 PICDEM 2 Plus Demonstration Board

The PICDEM 2 Plus demonstration board supports many 18-, 28-, and 40-pin microcontrollers, including PIC16F87X and PIC18FXX2 devices. All the necessary hardware and software is included to run the demonstration programs. The sample microcontrollers provided with the PICDEM 2 demonstration board can be programmed with a PRO MATE II device programmer, PICSTART Plus development programmer, or MPLAB ICD 2 with a Universal Programmer Adapter. The MPLAB ICD 2 and MPLAB ICE in-circuit emulators may also be used with the PICDEM 2 demonstration board to test firmware. A prototype area extends the circuitry for additional application components. Some of the features include an RS-232 interface, a 2 x 16 LCD display, a piezo speaker, an on-board temperature sensor, four LEDs, and sample PIC18F452 and PIC16F877 FLASH microcontrollers.

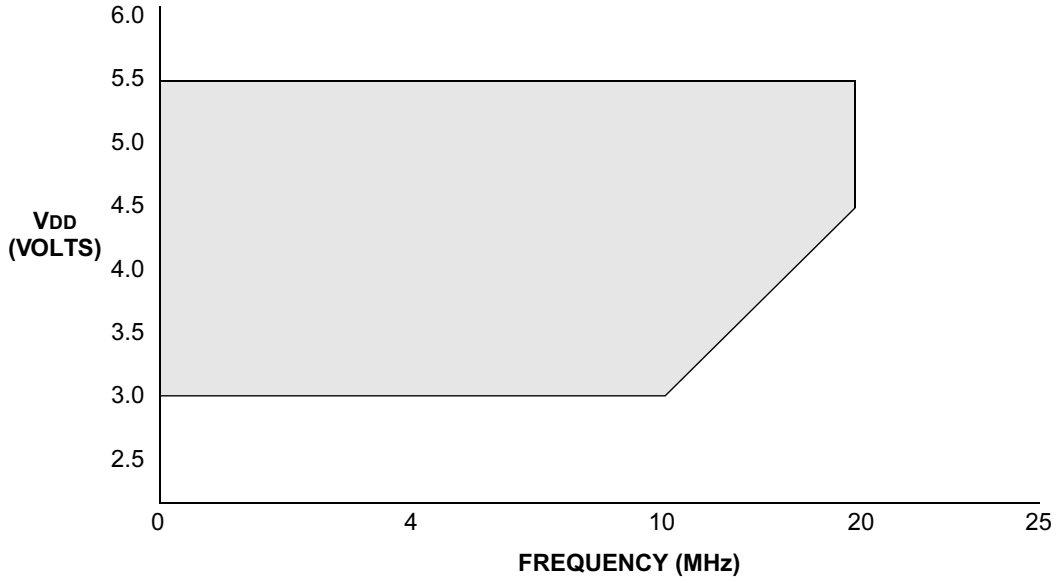
16.17 PICDEM 3 PIC16C92X Demonstration Board

The PICDEM 3 demonstration board supports the PIC16C923 and PIC16C924 in the PLCC package. All the necessary hardware and software is included to run the demonstration programs.

16.18 PICDEM 17 Demonstration Board

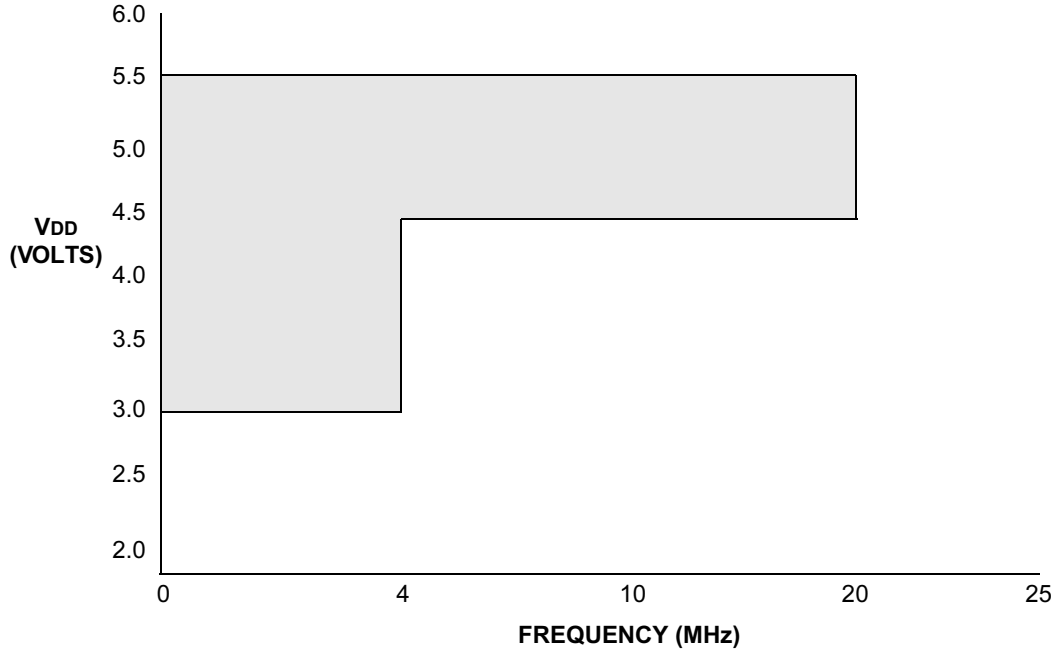
The PICDEM 17 demonstration board is an evaluation board that demonstrates the capabilities of several Microchip microcontrollers, including PIC17C752, PIC17C756A, PIC17C762 and PIC17C766. A programmed sample is included. The PRO MATE II device programmer, or the PICSTART Plus development programmer, can be used to reprogram the device for user tailored application development. The PICDEM 17 demonstration board supports program download and execution from external on-board FLASH memory. A generous prototype area is available for user hardware expansion.

FIGURE 17-1: PIC16F62X VOLTAGE-FREQUENCY GRAPH, 0°C ≤ TA ≤ +70°C



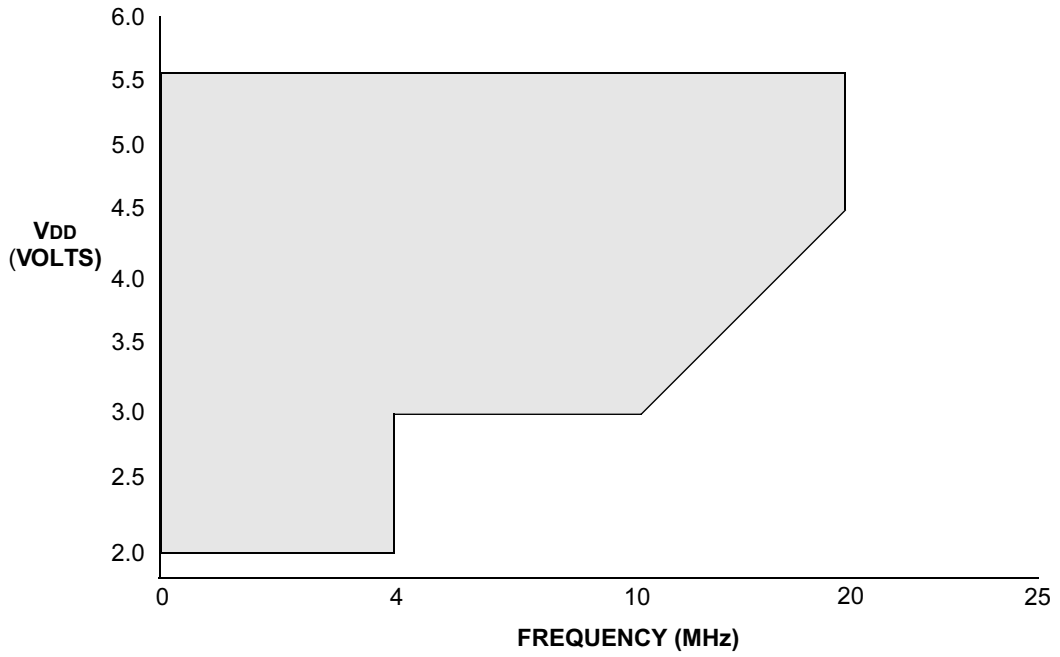
Note 1: The shaded region indicates the permissible combinations of voltage and frequency.

FIGURE 17-2: PIC16F62X VOLTAGE-FREQUENCY GRAPH, -40°C ≤ TA < 0°C, +70°C < TA ≤ 85°C



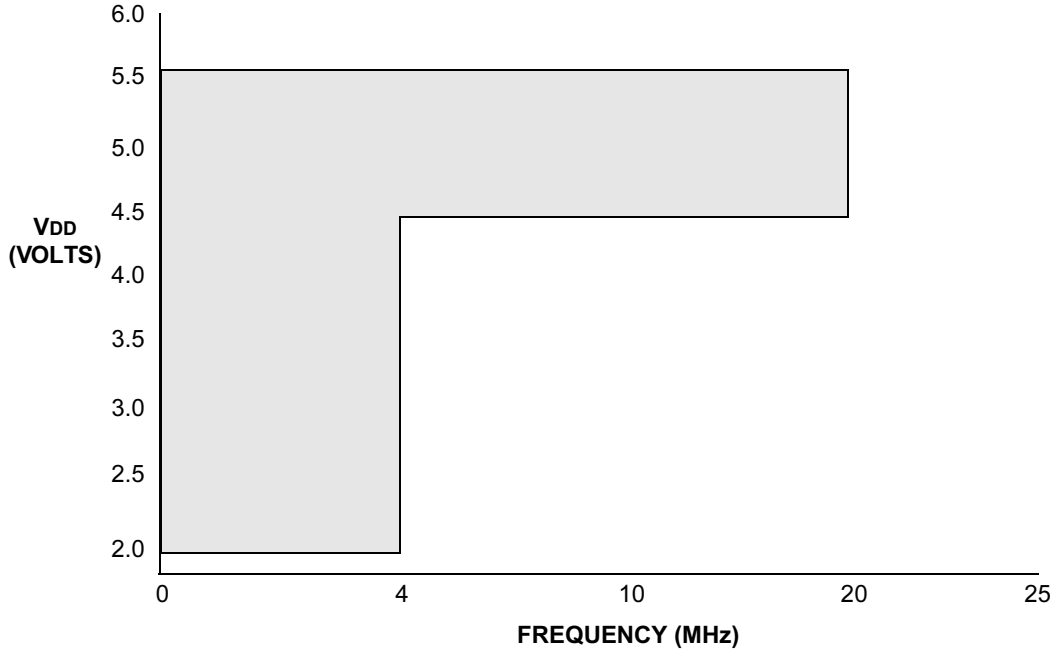
Note 1: The shaded region indicates the permissible combinations of voltage and frequency.

FIGURE 17-3: PIC16LF62X VOLTAGE-FREQUENCY GRAPH, 0°C ≤ TA ≤ +70°C



Note 1: The shaded region indicates the permissible combinations of voltage and frequency.

FIGURE 17-4: PIC16LF62X VOLTAGE-FREQUENCY GRAPH, -40°C ≤ TA < 0°C, +70°C < TA ≤ 85°C



Note 1: The shaded region indicates the permissible combinations of voltage and frequency.

TABLE 17-4: EXTERNAL CLOCK TIMING REQUIREMENTS

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
	Fosc	External CLKIN Frequency(1)	DC	—	4	MHz	XT and ER Osc mode, VDD = 5.0V
			DC	—	20	MHz	HS Osc mode
			DC	—	200	kHz	LP Osc mode
		Oscillator Frequency(1)		—	4	MHz	ER Osc mode, VDD = 5.0V
			0.1	—	4	MHz	XT Osc mode
			1	—	20	MHz	HS Osc mode
				—	200	kHz	LP Osc mode
			3.65	4	4.28	MHz	INTRC mode (fast), VDD = 5.0V
				37		kHz	INTRC mode (slow)
4	INTRC	Internal Calibrated RC	3.65	4.00	4.28	MHz	VDD = 5.0V
5	ER	External Biased ER Frequency	10 kHz		8 MHz		VDD = 5.0V
1	Tosc	External CLKIN Period(1)	250	—	—	ns	XT and ER Osc mode
			50	—	—	ns	HS Osc mode
			5	—	—	µs	LP Osc mode
		Oscillator Period(1)	250	—	—	ns	ER Osc mode
			250	—	10,000	ns	XT Osc mode
			50	—	1,000	ns	HS Osc mode
			5			µs	LP Osc mode
				250		ns	INTRC mode (fast)
				27		µs	INTRC mode (slow)
2	Tcy	Instruction Cycle Time	1.0	TCY	DC	ns	TCY = 4/FOSC
3	TosL, TosH	External CLKIN (OSC1) High External CLKIN Low	100 *	—	—	ns	XT oscillator, TOSC L/H duty cycle*

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (Tcy) equals four times the input oscillator time-based period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "Min." values with an external clock applied to the OSC1 pin. When an external clock input is used, the "Max" cycle time limit is "DC" (no clock) for all devices.

Note: The graphs and tables provided in this section are for design guidance and are not tested.

FIGURE 18-22: VIN vs VDD TTL

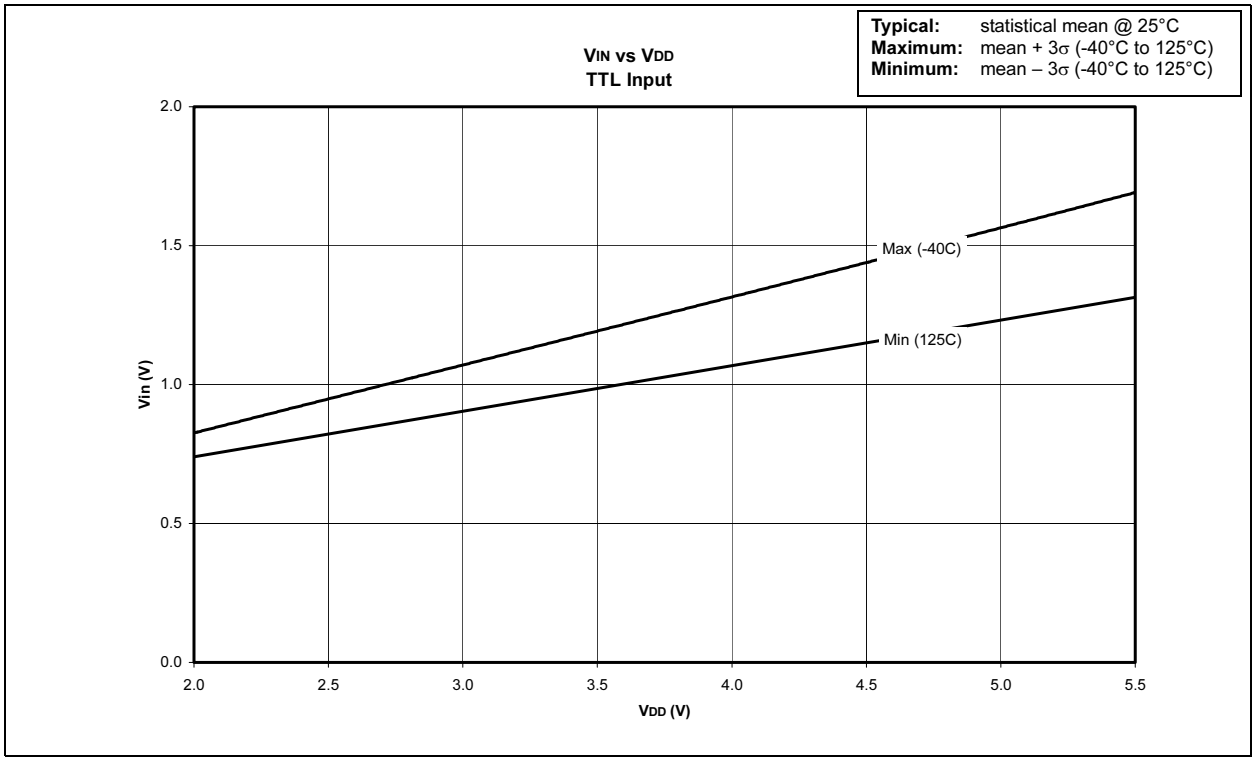


FIGURE 18-23: VIN vs VDD ST INPUT